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** CONTINUING DATA *****

EK (none)

** FOREIGN APPLICATIONS *****

JAPAN 2002-274300 09/20/2002 ✓
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EK

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 02/27/2004

Foreign Priority claimed	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no		
35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after allowance		
Verified and Acknowledged	Examiner's Signature Initials		
STATE OR COUNTRY	SHEETS	TOTAL	INDEPENDENT
JAPAN	DRAWING 3	CLAIMS 14	CLAIMS 3

ADDRESS

23548
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TITLE

Via-filling material and process for fabricating semiconductor integrated circuit using the material

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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